

CRMCGL1206A

N-Channel 120V,6.6mΩ Typ. Power MOSFET

Description

Features

• 120V, 90A

 $R_{DS(ON)}$ Typ =6.6m Ω @ V_{GS} = 10V

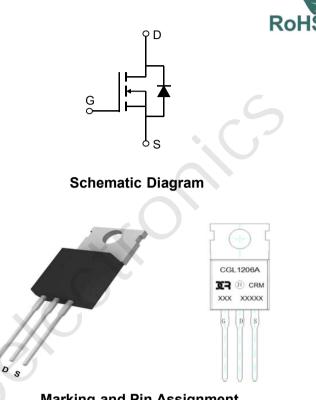
 $R_{DS(ON)}$ Typ =7.6m Ω @ V_{GS} = 4.5V

Advanced Split Gate Trench Technology

- Excellent $R_{\text{DS}(\text{ON})}$ and Low Gate Charge
- 100% UIS TESTED!
- 100% ΔVds TESTED!

Application

- Load Switch
- PWM Application
- Power Management



Marking and Pin Assignment

Package Marking and Ordering Information

Device	Marking	Package	Outline	TUBE(pcs)	Inner Box (pcs)	Per Carton (pcs)
CRMCGL1206A	CRMCGL1206A	TO-220C-3L	TUBE	50	1000	5000

G

Absolute Maximum Ratings (@ T_J = 25°C unless otherwise specified)

Symbol	Parameter		Value	Units
V _{DS}	Drain-to-Source Voltage		120	V
V _{GS}	Gate-to-Source Voltage		±20	V
	Continuous Drain Current	T _C = 25°C	90	А
I _D		T _C = 100°C	54	А
I _{DM}	Pulsed Drain Current ⁽¹⁾		360	А
E _{AS}	Single Pulsed Avalanche Energy ⁽²⁾		225	mJ
P _D	Power Dissipation	$T_c = 25^{\circ}C$	134	W
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case		0.93	°C/W
Τ _J , T _{stg}	Junction & Storage Temperature Range		-55 to 150	°C

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Electrical Characteristics (T_J = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Uni
Off Chara	acteristics					
V _{(BR)DSS}	Drain-Source Breakdown Voltage	$I_{D} = 250 \mu A, V_{GS} = 0 V$	120	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 120V, V _{GS} = 0V	-	-	1.0	μA
I _{GSS}	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±100	nA
On Chara	acteristics				G	
V _{GS(th)}	Gate Threshold Voltage	V_{DS} = V_{GS} , I_D = 250 μ A	1.4	1.9	2.6	V
D		V _{GS} = 10V, I _D = 30A	-	6.6	8.6	mΩ
R _{DS(ON)}	Static Drain-Source ON-Resistance ⁽³⁾	V _{GS} = 4.5V, I _D = 20A	-	7.6	9.9	mΩ
Dynamic	Characteristics					
C _{iss}	Input Capacitance		-	3364	-	pF
C _{oss}	Output Capacitance	V _{GS} = 0V, V _{DS} = 60V, f = 1MHz	Χ-	624	-	pF
C _{rss}	Reverse Transfer Capacitance			9.6	-	pF
Q _g	Total Gate Charge		J -	40	-	nC
Q_{gs}	Gate Source Charge	$V_{GS} = 0$ to 10V $V_{DS} = 60V$, $I_{D} = 20A$	-	9	-	nC
Q_{gd}	Gate Drain("Miller") Charge	$v_{\rm DS} = 00 v$, $v_{\rm D} = 20 A$	-	10	-	nC
Switchin	g Characteristics					
t _{d(on)}	Turn-On DelayTime		-	13	-	ns
t _r	Turn-On Rise Time	V _{GS} = 10V, V _{DD} = 60V	-	25	-	ns
$t_{d(off)}$	Turn-Off DelayTime	I_D = 30A, R_{GEN} = 6 Ω	-	38	-	ns
t _f	Turn-Off Fall Time		-	34	-	ns
Drain-So	urce Diode Characteristics and M	lax Ratings				
I _s	Maximum Continuous Drain to Source Diode Forward Current			-	90	А
I _{SM}	Maximum Pulsed Drain to Source Diode I	Forward Current	-	-	360	А
V_{SD}	Drain to Source Diode Forward Voltage	V _{GS} = 0V, I _S = 30A	-	-	1.2	V
trr	Body Diode Reverse Recovery Time	1 - 150 di/dt - 1000/	-	65	-	ns
Qrr	Body Diode Reverse Recovery Charge	I _F = 15A, di/dt = 100A/us	-	70	-	nC

Notes:

1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

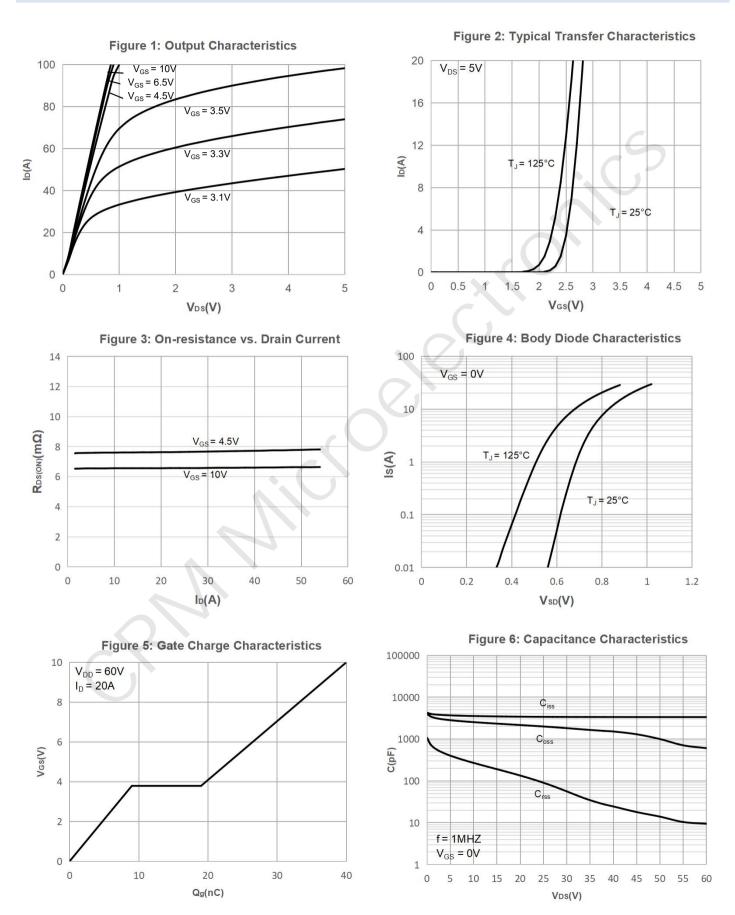
2. E_{AS} condition: Starting T_J=25°C, V_{DD}=50V, V_G=10V, R_G=250hm, L=0.5mH, I_{AS}=30A

3. Pulse Test: Pulse Width ${\leqslant}300\mu s,$ Duty Cycle ${\leqslant}0.5\%.$



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Typical Performance Characteristics





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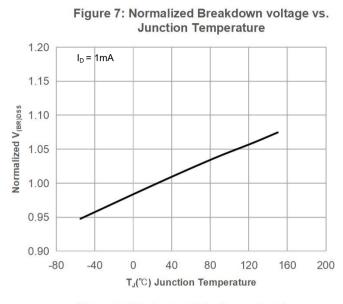
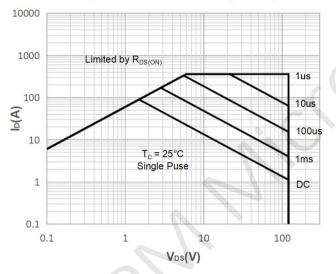
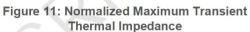
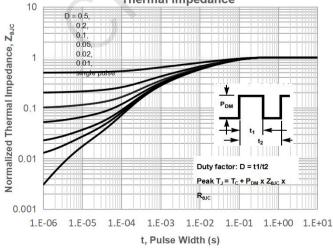
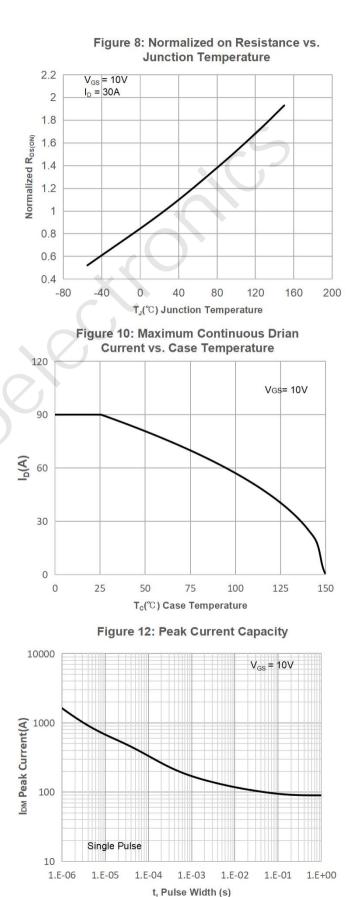


Figure 9: Maximum Safe Operating Area





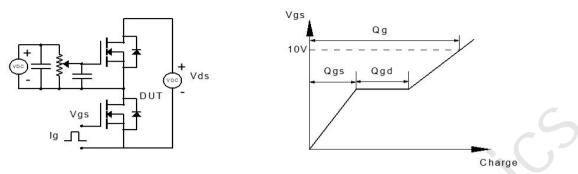






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Test Circuit





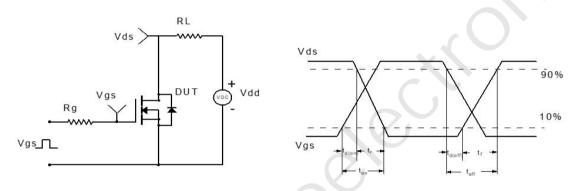
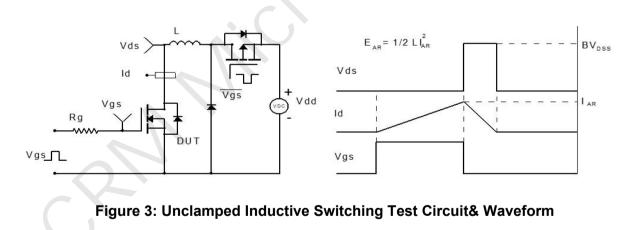


Figure 2: Resistive Switching Test Circuit & Waveform



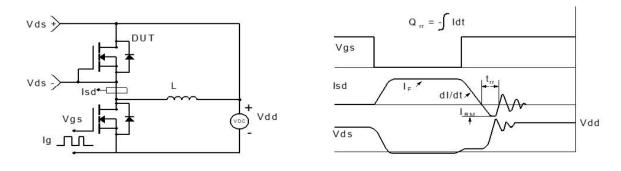
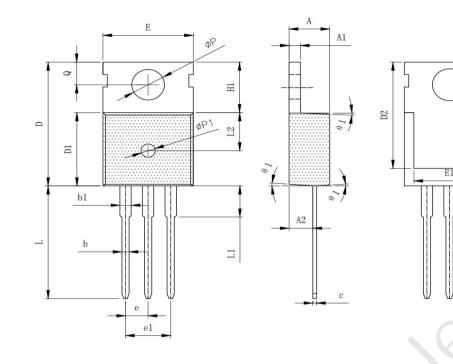


Figure 4: Diode Recovery Test Circuit & Waveform



Package Mechanical Data(TO-220C-3L)



SYMBOL	MILLIMETER				
SIMDUL	MIN	NOM	MAX		
A	4.40	4. 50	4.60		
A1	1.25	1.30	1.35		
A2	2.30	2.40	2.50		
b	0.70	0.80	0.90		
b1	1.25	1.35	1.45		
с	0.40	0.50	0.60		
D	15.50	15.80	16.10		
D1	9.10	9.20	9.30		
D2	12.73	12.83	12.93		
Е	9.70	9. 90	10.20		
E1	7.60	8.00	8.40		
е		2.54 (BSC)			
el		5.08 (BSC)			
H1	6.30	6.50	6.80		
L	12. 75	13.08	13.50		
Lì			3.10		
L2	4.30	4.60	4. 90		
ØP	3. 50	3.60	3. 70		
ØP1	1.40	1.50	1.60		
۵	2.70		2.90		
01	2°	4°	6°		

NOTES:1.PKG SURFACE IS MATTE Ral. 2~1.4; OTHERS IS POLISHED Ra0.15;

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Contact information

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